



Product Change Notification

Change Notification #: 115541 - 01
Change Title: Intel® NUC Board NUC5i3MYBE,
Intel® NUC Board NUC5i5MYBE,
Intel® NUC Kit NUC5i3MYHE,
Intel® NUC Kit NUC5i5MYHE,
PCN 115541-01, Product Design,
Documentation, Label, Product Material,
Transport Media,
BIOS Update, New Logo on Labels and
Flyer, the Addition of components and
ESD bag change,
**Reason for Revision: Correction to
Capacitor change, should have been
removal instead of addition.**

Date of Publication: August 16, 2017

Key Characteristics of the Change:

Product Design, Documentation, Label, Product Material, Transport Media

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Jun 26, 2017
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Description of Change to the Customer:

Reason for Revision: Correction to Capacitor change, should have been removal instead of addition.

1. The BIOS will be updated on the following SKUs:
 - BLKNUC5i3MYBE and BLKNUC5i3MYHE will be updated to BIOS MYBDWi30.86A.0041.EB.EXE
 - BLKNUC5i5MYBE and BLKNUC5i5MYHE will be updated to BIOS MYBDWi5v.86A.0035.EB.EXE

2. Added BSMI ROHS logo on the product and attention flyer as shown in the photographs below:

	Before	After
Rating Label		
Regulator Flyer	No BSMI information	
ESD Bag		

3. New supplier has been added for the RJ-45 LAN connector on the back panel.

4. **Removed** capacitors to enhance compatibility with a 3rd-party **passive** mini DisplayPort to HDMI cable/dongles.

Customer Impact of Change and Recommended Action:

It is recommended that customers evaluate this new BIOS to ensure a smooth transition. This change has been thoroughly evaluated to ensure that there are no quality or reliability implications to our customers. Intel validation of a new board revision does not include testing with older versions of BIOS.

The label, bag and documentation changes do not affect the functionality of the product. Customers should be aware of the changes and take any necessary steps to insure no impact for their receiving and processing of the product in their manufacturing.

Milestone dates are estimates and subject to change based on business and operational conditions.

Customer can expect to receive mixed inventory until current inventory levels are depleted.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Pre Change SA	Pre Change AA	Post Change TA	Post Change SA	Post Change AA
BLKNUC5I5MYHE	938688	H47799-106	H47796-207	H47797-207	H47799-107	H47796-208	H47797-208
BLKNUC5I5MYBE	938713			H47797-207			H47797-208
BLKNUC5I3MYHE	938715	H47786-106	H52443-206	H47781-206	H47786-107	H52443-207	H47781-207
BLKNUC5I3MYBE	938717			H47781-206			H47781-207

PCN Revision History:

Date of Revision:

May 24, 2017

August 16, 2017

Revision Number:

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01

Reason:

Originally Published PCN

Correction to Capacitor change,
should have been removal instead
of addition.



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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